SPIDER - TLE7244SL

8 Channel Protected Low-Side Relay Switch

Automotive Power



Never stop thinking



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SPI Driver for Enhanced Relay Control SPIDER - TLE7244SL

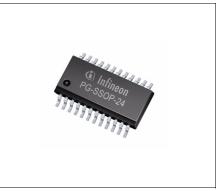
SPIDER - TLE7244SL



1 Overview

Features

- 4 input pins providing flexible PWM configuration
- Limp home functionality (direct driving) provided by a dedicated pin
- 16 bit SPI for diagnostics and control
- · Daisy chain capability also compatible with 8bit SPI devices
- Very wide range of digital supply voltage
- Green Product (RoHS compliant)
- AEC Qualified



PG-SSOP-24-7

Description

The SPIDER - TLE7244SL is a eight channel low-side switch in PG-SSOP-24-7 package providing embedded protective functions.

It is especially designed as relay driver in automotive applications.

A serial peripheral interface (SPI) is utilized for control and diagnosis of the device and the load.

For direct control and PWM there are four input pins available.

The device is monolithically integrated. The power transistors are built by N-channel MOSFETs.

Table 1 Basic Electrical data

Digital supply voltage	V _{DD}	3.0 V 5.5 V
Analog supply voltage	V_{DDA}	4.5 V 5.5 V
Max. ON State resistance at T_j = 150°C for each channel	$R_{\rm DS(ON,max)}$	1.7 Ω
Nominal load current	$I_{\rm L (nom)}$	290 mA
Overload switch off threshold	I _{D (OVL,max)}	950 mA
Output leakage current per channel at 25 °C	I _{D (STB,max)}	1 μΑ
Drain to Source clamping voltage	$V_{\rm DS(AZ)}$	41 V
Maximum SPI clock frequency	$f_{\rm SCLK,max}$	5 MHz

Diagnostic Features

- latched diagnostic information via SPI register
- Overtemperature monitoring
- Overload detection in ON state
- Open load detection in OFF state

Туре	Package	Marking
SPIDER - TLE7244SL	PG-SSOP-24-7	TLE7244SL



Overview

Protection Functions

- Short circuit
- Over load
- Over temperature
- Electrostatic discharge (ESD)

Application

- All types of resistive, inductive and capacitive loads
- · Especially designed for driving relays in automotive applications

Detailed Description

The SPIDER - TLE7244SL is a eight channel low-side relay switch designed for typical automotive relays providing embedded protective functions. The PG-SSOP-24-7 package is used to get a footprint optimized solution. The 16 bit serial peripheral interface (SPI) is utilized for control and diagnosis of the device and the loads. The SPI interface provides daisy chain capability.

The SPIDER - TLE7244SL is equipped with four input pins that can be individually routed to the output control of their dedicated channels thus offering flexibility in design and PCB layout. The input multiplexer is controlled via SPI.

There is a dedicated limp home pin LHI which provides a straightforward usage of the input pins as dedicated driver for four outputs.

The device provides full diagnosis of the load, which is open load as well as short circuit detection. The SPI diagnosis bits indicate latched fault conditions that may have occurred.

Each output stage is protected against short circuit. In case of over load, the affected channel switches off. There are temperature sensors available for each channel to protect the device in case of over temperature.

The device is supplied by two power supply lines. The analog supply supports 5 V, the digital supply offers a very wide flexibility in supply voltage ranging from 3.0 V up to 5.5 V.

The power transistors are built by N-channel vertical power MOSFETs. The inputs are ground referenced CMOS compatible. The device is monolithically integrated in Smart Power Technology.

In terms of PCB layout improvement, all output pins are available at one side of the device. The other side bundles the signals to the micro-controller.



Block Diagram

2 Block Diagram

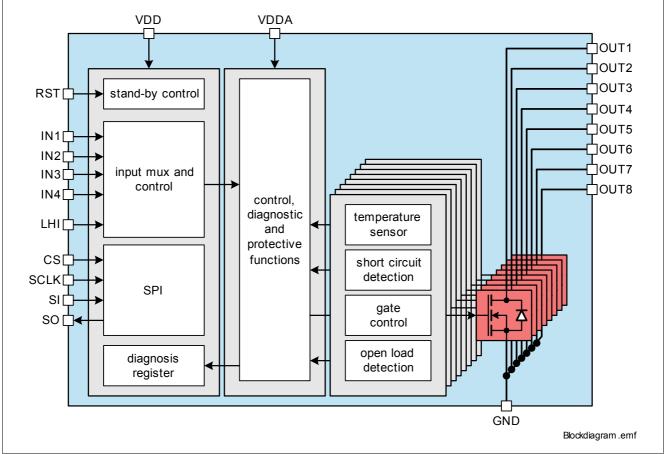


Figure 1 Block Diagram for the SPIDER - TLE7244SL



Pin Configuration

3 Pin Configuration

3.1 Pin Assignment

	(top view)		
GND 🗆	1•	24 💷 VDDA	
GND 🗆	2	$23 \square \overline{CS}$	
OUT1 🗔	3	22 🗔 SI	
OUT2 🗆	4	21 \square RST	
OUT3 🗔	5		
OUT4 🗔	6	19 🗔 SO	
OUT5 🗔	7	18 🗔 LHI	
OUT6 🗆	8	17 🛄 IN1	
OUT7 🗆	9	16 🔟 IN2	
	10	15 🔟 IN3	
GND 🗆	11	14 🛄 IN4	
GND 🗆	12	13 🔟 VDD	
			Pinout.emf
Figure 2 Pin Configuration			1 #1000.0111

3.2 Pin Definitions and Functions

Pin	Symbol	I/O	1)	Function				
Power Su	ipply							
13	VDD	-		Digital Supply Voltage; Connected to 3.3V or 5V Voltage with Reverse protection Diode and Filter against EMC				
24	VDDA	-		Analog Supply Voltage; Connected to 5V Voltage with Reverse protection Diode and Filter against EMC				
1,2,11,12	GND	-		Ground; common ground for digital, analog and power				
Power St	ages	ł						
3	OUT1	0		utput Channel 1; Drain of power transistor channel 1				
4	OUT2	0		Output Channel 2; Drain of power transistor channel 2				
5	OUT3	0		Output Channel 3; Drain of power transistor channel 3				
6	OUT4	0		Output Channel 4; Drain of power transistor channel 4				
7	OUT5	0		Output Channel 5; Drain of power transistor channel 5				
8	OUT6	0		Output Channel 6; Drain of power transistor channel 6				
9	OUT7	0		Output Channel 7; Drain of power transistor channel 7				
10	OUT8	0		Output Channel 8; Drain of power transistor channel 8				
Inputs	l							
17	IN1	I	PD	Control Input; Digital input 3.3 V or 5V. In case of not used keep open.				
16	IN2	I	PD	Control Input; Digital input 3.3 V or 5V. In case of not used keep open.				

20



Pin Configuration

Pin	Symbol	I/O	1)	Function
15	IN3	I	PD	Control Input; Digital input 3.3 V or 5V. In case of not used keep open.
14	IN4	I	PD	Control Input; Digital input 3.3 V or 5V. In case of not used keep open.
18	LHI	I	PD	Limp Home; Digital input 3.3 V or 5V. In case of not used keep open.
21	RST	I	PD	Reset input pin; Digital input 3.3 V or 5V. Low active
SPI	I			
23	CS	I	PU	SPI chip select; Digital input 3.3 V or 5V. Low active
20	SCLK	I	PD	serial clock; Digital input 3.3 V or 5V.
22	SI	I	PD	serial data in; Digital input 3.3 V or 5V.
19	SO	0		serial data out; Digital output with voltage level referring to V_{DD} .

1) O: Output, I: Input,

PD: pull-down resistor integrated, PU: pull-up resistor integrated

Datasheet



Pin Configuration

3.3 Voltage and Current naming definition

Figure 3 shows all the terms used in this data sheet, with associated convention for positive values.

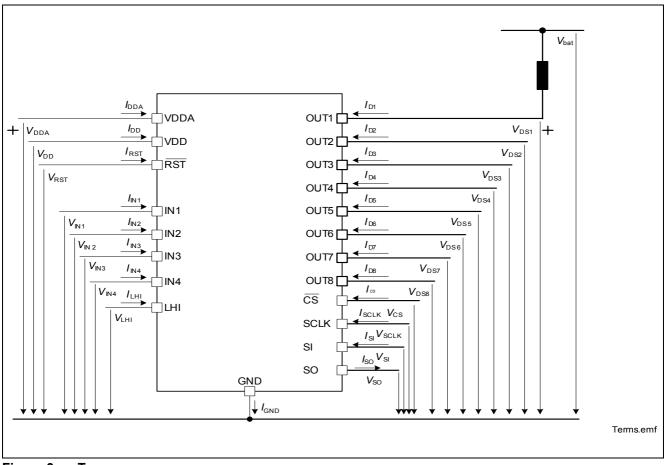


Figure 3 Terms



General Product Characteristics

4 General Product Characteristics

4.1 Absolute Maximum Ratings

Absolute Maximum Ratings ¹⁾

Unless otherwise specified: $T_{\rm j}$ = -40 °C to +150 °C; $V_{\rm DD}$ = 3.0 V to V_{DDA}, $V_{\rm DDA}$ = 4.5V to 5.5V all voltages with respect to ground, positive current flowing into pin

Pos.	Parameter	Symbol	Lim	it Values	Unit	Conditions	
			Min.	Max.			
Power	Supply	.	-		-	-	
4.1.1	Digital supply voltage	V_{DD}	-0.3	5.5	V	-	
4.1.2	Analog supply voltage	V _{DDA}	-0.3	5.5	V	-	
4.1.3	Output voltage for short circuit protection (single pulse)	V _{OUT}	0	36	V	-	
Power	Stages	.	-		-	-	
4.1.4	Load current	ID	-0.5	0.5	А		
4.1.5	Voltage at power transistor	V _{DS}	_	41	V	active clamped	
4.1.6	Maximum energy dissipation one channel	E _{AS}			mJ	²⁾ V _{bat} =16V, V _{clamp} =45V, t _{pulse} = 4 ms	
	single pulse		_	150		<i>T</i> _{j(0)} = 150 °C <i>I</i> _{D(0)} =0.50 A	
	repetitive ($1 \cdot 10^4$ cycles) repetitive ($1 \cdot 10^6$ cycles)	E _{AR}		100 60		$T_{j(0)} = 105 \text{ °C}$ $I_{D(0)} = 0.40 \text{ A}$ $I_{D(0)} = 0.40 \text{ A}$	
Logic P	Pins						
4.1.7	IN1,IN2,IN3,IN4;Voltage at input pins	$V_{\rm IN}$	-0.3	5.5	V		
4.1.8	RST; Voltage at reset pin	V_{RST}	-0.3	5.5	V		
4.1.9	LHI; Voltage at limp home input pin	V_{LHI}	-0.3	5.5	V		
4.1.10	CS; Voltage at chip select	V _{CS}	-0.3	V _{DD} + 0.3	V	3)	
4.1.11	SCLK; Voltage at serial clock pin	$V_{\rm SCLK}$	-0.3	V _{DD} + 0.3	V	3)	
4.1.12	SI; Voltage at serial input pin	$V_{\rm SI}$	-0.3	V _{DD} + 0.3	V	3)	
4.1.13	SO; Voltage at serial output pin	V _{SO}	-0.3	V _{DD} + 0.3	V	3)	
Temper	ratures				·		
4.1.14	Junction Temperature	Tj	-40	150	°C	-	
4.1.15	Storage Temperature	T _{stg}	-55	150	°C	-	
ESD Su	isceptibility						
4.1.16	ESD Resistivity	V_{ESD}	-4	4	kV	HBM ⁴⁾	
1) Not s	subject to production test, specified by design.	+	+	I			

1) Not subject to production test, specified by design.

2) Pulse shape represents inductive switch off: $I_D(t) = I_D(0) \times (1 - t / t_{pulse}); 0 < t < t_{pulse}$

3) level must not exceed $V_{\rm DD}$ +0.3V < 5.5 V

4) ESD susceptibility, HBM according to EIA/JESD 22-A114



General Product Characteristics

- Note: Stresses above the ones listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
- Note: Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.

4.2 Functional Range

Pos.	Parameter	Symbol	Lir	nit Values	Unit	Conditions
			Min.	Max.		
4.2.1	Digital supply voltage	$V_{\rm DD}$	3.0	5.5	V	_
4.2.1	Analog supply voltage	V_{DDA}	4.5	5.5	V	-
4.2.2	extended supply range	V _{DDA}	4.0	4.5		parameter deviations are possible
4.2.3	Digital Supply current in reset mode	I _{DD(RST)}	-	10	μA	T _i = 85 °C
4.2.4	Digital supply current (all channels active)	I _{DD(ON)}	_	0.5	mA	$V_{DD} = V_{DDA} = 5 V$ $V_{RST} = V_{CS} = V_{DD}$ $V_{SCLK} = 0 V$ $V_{IN} = 0 V$
4.2.5	Analog supply current (all channels active)	$I_{\rm DDA(ON)}$	-	5	mA	

Note: Within the functional range the IC operates as described in the circuit description. The electrical characteristics are specified within the conditions given in the related electrical characteristics table.

4.3 Thermal Resistance

Note: This thermal data was generated in accordance with JEDEC JESD51 standards. For more information, go to www.jedec.org.

Pos.	Parameter	Symbol	I	Limit Val	ues	Unit	Conditions
			Min.	Тур.	Max.		
4.3.6	Junction to Soldering Point	R _{thJSP}	-	-	25	K/W	1) 2)
4.3.7	Junction to Ambient (1s0p+600mm ² Cu)	R _{thJA}	-	68	-	K/W	1) 3)
4.3.8	Junction to Ambient (2s2p)	R _{thJA}	-	58	-	K/W	1) 4)

1) Not subject to production test, specified by design

2) Specified R_{thJSP} value is simulated at natural convection on a cold plate setup (all pins are fixed to ambient temperature). $T_{a} = 25 \text{ °C. LS1}$ to LS8 are dissipating 1 W power (0.125 W each).

3) Specified R_{thJA} value is according to Jedec JESD51-2,-3 at natural convection on FR4 1s0p board; The product (Chip+Package) was simulated on a 76.2 x 114.3 x 1.5 mm board with additional heatspreading copper area of 600mm² and 70 μ m thickness. T_a = 25 °C, LS1 to LS8 are dissipating 1 W power (0.125 W each).

4) Specified R_{thJA} value is according to Jedec JESD51-2,-7 at natural convection on FR4 2s2p board; The product (Chip+Package) was simulated on a 76.2 x 114.3 x 1.5 mm board with 2 inner copper layers (2 x 70 μm Cu, 2 x 35 μm Cu).
 T_a = 25 °C, LS1 to LS8 are dissipating 1 W power (0.125 W each).



5 Input and Power Stages

The SPIDER - TLE7244SL is a eight channel low-side relay switch.

The power stages are built by N-channel vertical power MOSFET transistors.

5.1 Power Supply

The SPIDER - TLE7244SL is supplied by two power supply lines $V_{\rm DD}$ and $V_{\rm DDA}$.

The digital power supply line V_{DD} is designed to be functional at a very wide voltage range. The analog power supply V_{DDA} supports 5 V supply.

There are power-on reset functions implemented for both supply lines. After start-up of the power supply, all SPI registers are reset to their default values and the device is in stand-by mode. Capacitors at pins $V_{\rm DD}$ -GND and $V_{\rm DDA}$ -GND are recommended.

There is a reset pin available. Low level at this pin causes all registers to be set to their default values and the quiescent supply currents are minimized.

5.1.1 Limp Home Mode

The SPIDER - TLE7244SL offers the capability of driving dedicated channels during eventual fail-safe operation of the system. This limp home mode is activated by a high signal at pin LHI. In this mode, the SPI registers are reset and the input pins are directly routed to their corresponding channels OUT1 to OUT4, see **Table 2** for details. OUT5 to OUT8 are turned off in limp home mode. Furthermore, the SPI is ignored and all input pin are referred to V_{DDA} in order to ensure a defined operation mode if the digital supply or the microcontroller fail.

A high signal on LHI overrides a Reset signal on RST. In case of a limp home during standby the device will therefore wake up and enter the limp home mode.

After limp home operation all registers are reset and the device enters in standby mode following low logic RST state, or returns to idle (all channels OFF). Next SPI transmission will receive a TER Flag.

Input	controlled
	Output
IN1	OUT1
IN2	OUT2
IN3	OUT3
IN4	OUT4

 Table 2
 Routing during limp home mode

5.2 Input Circuit

There are four input pins available at SPIDER - TLE7244SL, which can be configured to be used for control of the output stages. The INn parameter of the SPI selects the input pin to be used. Figure 4 shows the input circuit of SPIDER - TLE7244SL.

During Limp home mode a default routing is switched and the SPI commands are ignored.



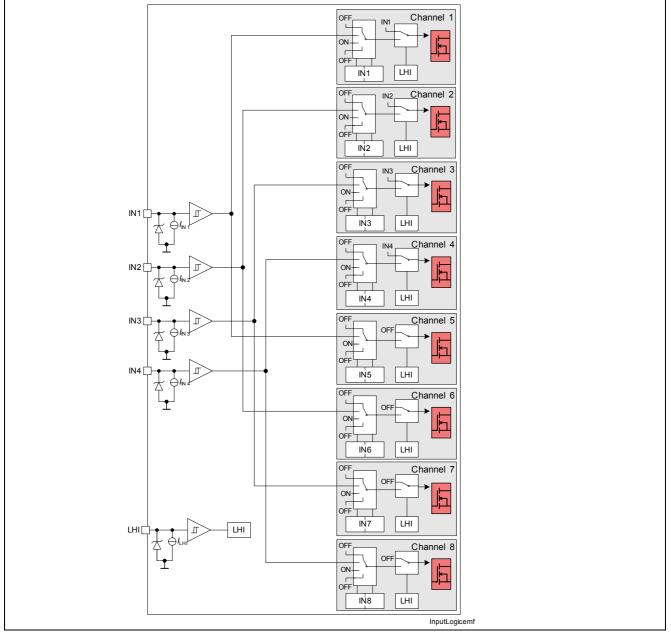


Figure 4 Input matrix and logic

The current sink to ground ensures that the channels switch off in case of open input pin. The zener diode protects the input circuit against ESD pulses. After power-on reset, the device enters idle mode (all channel OFF).

5.2.1 Inductive Output Clamp

When switching off inductive loads, the potential at pin OUT rises to $V_{\text{DS(CL)}}$ potential, because the inductance intends to continue driving the current. The voltage clamping is necessary to prevent destruction of the device, see **Figure 5** for details. Nevertheless, the maximum allowed load inductance is limited.



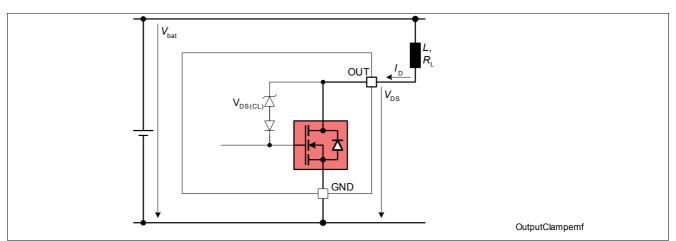


Figure 5 Output Clamp Implementation

Maximum Load Inductance

During demagnetization of inductive loads, energy has to be dissipated in the SPIDER - TLE7244SL. This energy can be calculated with following equation:

$$E = V_{\text{DS(CL)}} \cdot \left[\frac{V_{\text{bat}} - V_{\text{DS(CL)}}}{R_{\text{L}}} \cdot \ln \left(1 - \frac{R_{\text{L}} \cdot I_{\text{L}}}{V_{\text{bat}} - V_{\text{DS(CL)}}} \right) + I_{\text{L}} \right] \cdot \frac{L}{R_{\text{L}}}$$

Following equation simplifies under the assumption of $R_{\rm L}$ = 0:

$$E = \frac{1}{2}LI_{L}^{2} \cdot \left(1 - \frac{V_{bat}}{V_{bat} - V_{DS(CL)}}\right)$$

The maximum energy, which is converted into heat, is limited by the thermal design of the component.

5.2.2 Timing Diagrams

The power transistors are switched on and off with a dedicated slope via the IN bits of the serial peripheral interface SPI. The switching times t_{ON} and t_{OFF} are designed equally.

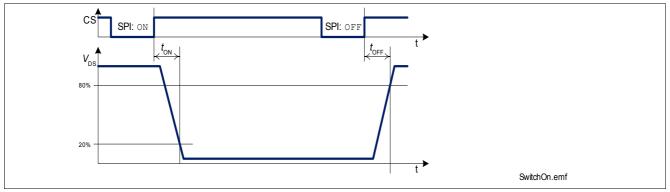


Figure 6 Switching a Resistive Load

In input mode, a high signal at the input pin is equivalent to a SPI ON command and a low signal to SPI OFF command respectively. Please refer to **Section 8.3** for details on operation modes.



5.3 Input and Power Stages Characteristics

Note: Characteristics show the deviation of parameter at given supply voltage and junction temperature. Typical values show the typical parameters expected from manufacturing.

Electrical Characteristics: Supply and Input

All voltages with respect to ground, positive current flowing into pin

unless otherwise specified: $V_{\rm DD}$ = 3.0 V to V_{DDA}, $V_{\rm DDA}$ = 4.5V to 5.5V, $T_{\rm j}$ = -40 °C to +150 °C

Pos.	Parameter	Symbol		Limit Val	ues	Unit	Conditions	
			Min.	Тур.	Max.			
Power	Supply							
5.3.1	Digital supply voltage	$V_{\rm DD}$	3.0	-	5.5	V		
5.3.2	Digital supply current, all channels ON	I _{DD(ON)}	-	-	0.5	mA	$V_{DD} = V_{DDA} = 5 V$ $V_{RST} = V_{CS} = V_{DD}$ $V_{SCLK} = 0 V$ $V_{IN} = 0 V$	
5.3.3	Digital supply stand-by current, all channels in stand-by mode	I _{DD(STB)}			20 20 40	μA	$f_{SCLK} = 0 \text{ Hz}$ $V_{CS} = V_{DD}$ $T_j = 25 \text{ °C}^{-1}$ $T_j = 85 \text{ °C}^{-1}$ $T_i = 150 \text{ °C}$	
5.3.4	Digital supply reset current	I _{DD(RST)}	- -		10 10 20	μΑ	$V_{\text{RST}} = V_{\text{LHI}} = 0 \text{ V}$ $T_j = 25 \text{ °C}^{-1}$ $T_j = 85 \text{ °C}^{-1}$ $T_j = 150 \text{ °C}$	
5.3.5	Digital power-on reset threshold voltage	V _{DD(PO)}		-	2.7	V		
5.3.6	Analog supply voltage	V_{DDA}	4.5	-	5.5	V		
5.3.7	Analog supply current all channels ON	$I_{\rm DDA(ON)}$	-	-	5	mA		
5.3.8	Analog supply stand-by current all channels in stand-by mode	$I_{\rm DDA(STB)}$			20 20 40	μΑ	$V_{CS} = V_{DD}$ $V_{SI} = 0 V$ $V_{SCLK} = 0 V$ $T_{j} = 25 \circ C^{-1}$ $T_{j} = 85 \circ C^{-1}$ $T_{j} = 150 \circ C$	
5.3.9	Analog supply reset current	I _{DDA(RST)}	- - -	- - - -	5 5 20	μΑ	$V_{\text{RST}} = V_{\text{LHI}} = 0 \text{ V}$ $T_j = 25 \text{ °C}^{-1}$ $T_j = 85 \text{ °C}^{-1}$ $T_j = 150 \text{ °C}$	
5.3.10	Analog power-on reset threshold voltage	V _{DDA(PO)}	-	-	4.0	V		



Electrical Characteristics: Supply and Input

All voltages with respect to ground, positive current flowing into pin unless otherwise specified: V_{DD} = 3.0 V to V_{DDA}, V_{DDA} = 4.5V to 5.5V, T_i = -40 °C to +150 °C

Pos.	Parameter	Symbol		Limit Val	ues	Unit	Conditions
			Min.	Тур.	Max.		
Output	characteristics	1	-				
5.3.11	On-State resistance per channel	R _{DS(ON)}	-	0.8	-	Ω	$I_{\rm L}$ = 400 mA $T_{\rm i}$ = 25 °C ¹⁾
			-	1.4	1.7		$I_{\rm L}$ = 400 mA $T_{\rm i}$ = 150 °C
5.3.12	Nominal load current	I _{L(nom)}	290	-	-	mA	¹⁾ all channels on $T_a = 85 \text{ °C}$ $T_{j,max} = 150 \text{ °C}$ based on $R_{thja,2s2}$
5.3.13	Output leakage current in stand-by mode (per channel)	I _{D(STB)}			1 2 5	μA	$V_{\rm DS}$ = 13.5 V $T_{\rm j}$ = 25 °C ¹⁾ $T_{\rm j}$ = 85 °C ¹⁾ $T_{\rm j}$ = 150 °C
5.3.14	Output clamping voltage	V _{DS(CL)}	41	-	54	V	
Input C	haracteristics				·	·	
5.3.15	L level of pins IN1IN4 and LHI	$V_{\rm IN(L)}$	0	-	0.6	V	
5.3.16	H level of pins IN1IN4 and LHI	V _{IN(H)}	2.0	_	5.5	V	2)
5.3.17	L-input pull-down current through pin IN	$I_{\rm IN(L)}$	3	12	80	μA	¹⁾ $V_{\rm IN}$ = 0.6 V
5.3.18	H-input pull-down current through pin IN	I _{IN(H)}	10	40	80	μA	$V_{\rm DD} = 5.5 \text{ V}$ $V_{\rm IN} = V_{\rm DD}$
Reset C	Characteristics						
5.3.19	L level of pin RST	$V_{\rm RST(L)}$	0	-	0.2* V _{DD}		
5.3.20	H level of pin RST	V _{RST(H)}	0.4* V _{DD}	-	V _{DD}		
5.3.21	L-input pull-down current through pin RST	$I_{\rm RST(L)}$	3	12	80	μA	¹⁾ $V_{\rm RST}$ = 0.6 V
5.3.22	H-input pull-down current through pin RST	$I_{\rm RST(H)}$	10	40	80	μA	$V_{\rm DD}$ = 5.5 V $V_{\rm RST}$ = $V_{\rm DD}$
Timing		1					
5.3.23	Reset wake-up time	t _{wu(RST)}	-	-	200	μS	
5.3.24	Reset and LHI signal duration	t _{RST(L)}	50	_	-	μS	
5.3.25	Turn-on time $V_{\rm DS}$ = 20% $V_{\rm bat}$ all channels	t _{ON}		30	50	μs	V_{bat} = 13.5 V resistive load I_{DS} = 180 mA
5.3.26	Turn-off time V_{DS} = 80% V_{bb} all channels	t _{OFF}	-	30	50	μS	$\frac{V_{\text{bat}}}{I_{\text{DS}}} = 13.5 \text{ V}$ resistive load $I_{\text{DS}} = 180 \text{ mA}$

1) Not subject to production test, specified by design.

2) level must not exceed $V_{\rm DD}$ +0.3V < 5.5 V



Protection Functions

6 Protection Functions

The device provides embedded protective functions. Integrated protection functions are designed to prevent IC destruction under fault conditions described in this datasheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.

6.1 Over Load Protection

The SPIDER - TLE7244SL is protected in case of over load or short circuit of the load. After time $t_{OFF(OVL)}$, the over loaded channel n switches off and the according diagnosis flag Dn is set. The channel can be switched on after clearing the diagnosis flag. Please refer to Figure 7 for details.

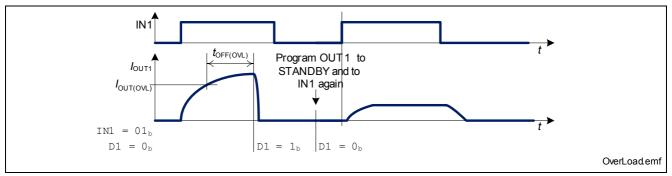


Figure 7 Shut down at over load

The current sink to ground ensures that the channels switch off in case of open input pin. The zener diode protects the input circuit against ESD pulses. After power-on reset, the device enters idle mode.

6.2 Over Temperature Protection

A temperature sensor for each channel causes an overheated channel n to switch off to prevent destruction and the according diagnosis flag Dn is set. The channel can be switched on after clearing the diagnosis flag. Please refer to **Chapter 7.1** for information on diagnosis features.

6.3 Reverse Polarity Protection

In case of reverse polarity, the intrinsic body diode of the power transistor causes power dissipation. The reverse current through the intrinsic body diode of the power transistor has to be limited by the connected load. The $V_{\rm DD}$ and $V_{\rm DDA}$ supply pins must be protected against reverse polarity externally. The over temperature and over load protection is not active during reverse polarity.



Protection Functions

6.4 **Protection Characteristics**

Note: Characteristics show the deviation of parameter at given supply voltage and junction temperature. Typical values show the typical parameters expected from manufacturing.

Electrical Characteristics: Protection

All voltages with respect to ground, positive current flowing into pin

unless otherwise specified: $V_{\rm DD}$ = 3.0 V to V_{DDA}, $V_{\rm DDA}$ = 4.5V to 5.5V, $T_{\rm j}$ = -40 °C to +150 °C

Pos.	Parameter	Symbol		Limit Val	ues	Unit	Conditions
			Min.	Тур.	Max.		
Over L	oad Protection		-			1	
6.4.1	Over load detection current	I _{D(OVL)}	0.5		0.95	А	
	all channels						
6.4.2	Over load shut-down delay time	t _{OFF(OVL)}	3		50	μS	
Over T	emperature Protection						
6.4.3	Thermal shut down temperature	T _{j(SC)}	150	170 ¹⁾		°C	
1) Not	subject to production test, specified by d	esign					



Diagnosis Features

7 Diagnosis Features

The SPI of SPIDER - TLE7244SL provides diagnosis information about the device and about the load. There are following diagnosis flags implemented:

The diagnosis information of the protective functions of channel n is latched in the diagnosis flag Dn.

The open load diagnosis of channel n is latched in the diagnosis flag OLn.

Both flags are cleared by programming the specific channel to Standby (STB).

Failure Mode	Comment					
Open Load or short circuit to ground	Diagnosis, when channel n is switched on: none Diagnosis, when channel n is switched off: according to voltage level at the output pin, flag OLn is set after time $t_{d(OL)}$. When the channel is in OFF there is Diagnosis active, in Standby the Diagnosis is not enabled					
Over Temperature	When over temperature occurs, the according diagnosis flag Dn is set. If the affected channel was active it is switched off. The diagnosis flags are latched until they have been cleared by programming the channel STI					
Over Load (Short Circuit)	When over load is detected at channel n, the affected channel is switched off after time $t_{OFF(OVL)}$ and the dedicated diagnosis flag Dn is set. The diagnosis flags are latched until they have been cleared by programming the channel STB					

7.1 Diagnosis Characteristics

Note: Characteristics show the deviation of parameter at given supply voltage and junction temperature. Typical values show the typical parameters expected from manufacturing.

Electrical Characteristics: Diagnosis

All voltages with respect to ground, positive current flowing into pin

unless otherwise specified: V_{DD} = 3.0 V to V_{DDA}, V_{DDA} = 4.5V to 5.5V, T_i = -40 °C to +150 °C

Pos.	Parameter	Symbol	I	Limit Val	ues	Unit	Conditions	
			Min.	Тур.	Max.			
OFF St	tate Diagnosis		1					
7.1.1	Open load detection threshold voltage	V _{DS(OL)}	1.0		2.5	V		
7.1.2	Output pull-down diagnosis current per channel	I _{D(PD)}			80	μA	V _{DS} = 13.5 V	
7.1.3	Open load diagnosis delay time	t _{d(OL)}	30		200	μS		
ON Sta	ate Diagnosis						- L	
7.1.4	Over load detection current	$I_{\rm D(OVL)}$	0.5		0.95	А		
7.1.5	Over load detection delay time	t _{OFF(OVL)}	3		50	μS		



8 Serial Peripheral Interface (SPI)

The diagnosis and control interface is based on a serial peripheral interface (SPI).

The SPI is a full duplex synchronous serial slave interface, which uses four lines: SO, SI, SCLK and \overline{CS} . Data is transferred by the lines SI and SO at the data rate given by SCLK. The falling edge of \overline{CS} indicates the beginning of a data access. Data is sampled in on line SI at the falling edge of SCLK and shifted out on line SO at the rising edge of SCLK. Each access must be terminated by a rising edge of \overline{CS} . A modulo 8 counter ensures that data is taken only, when a multiple of 8 bit has been transferred, while the minimum of 16 bit is also taken into consideration. Therefore the interface provides daisy chain capability even with 8 bit SPI devices.

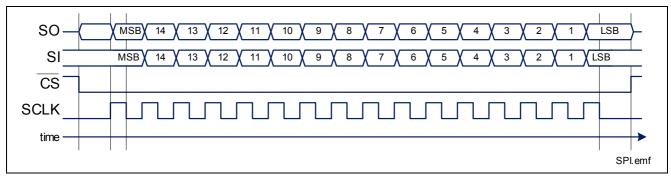


Figure 8 Serial peripheral interface

The SPI protocol is described in Section 8.3. It is reset to the default values after power-on reset.

8.1 SPI Signal Description

CS - Chip Select:

The system micro controller selects the SPIDER - TLE7244SL by means of the \overline{CS} pin. Whenever the pin is in low state, data transfer can take place. When \overline{CS} is in high state, any signals at the SCLK and SI pins are ignored and SO is forced into a high impedance state.

CS High to Low transition:

- The diagnosis information is transferred into the shift register.
- SO changes from high impedance state to high or low state depending on the logic OR combination between the transmission error flag (TER) and the signal level at pin SI. As a result, even in daisy chain configuration, a high signal indicates a faulty transmission. The transmission error flag is set after any kind of reset, so a reset between two SPI commands is indicated. For details, please refer to Figure 9. This information stays available to the first rising edge of SCLK.

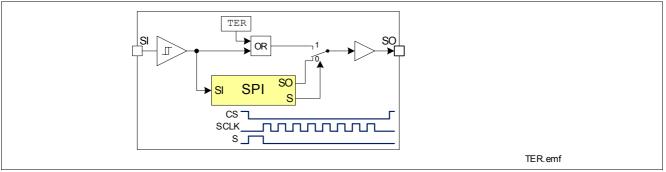


Figure 9 Transmission Error Flag on SO Line



CS Low to High transition:

Data from shift register is transferred into the input matrix register only, when after the falling edge of \overline{CS} exactly a multiple (1, 2, 3, ...) of eight SCLK signals have been detected, while the minimum valid length is of course 16 clocks for the 16 register bits of SPIDER - TLE7244SL.

SCLK - Serial Clock:

This input pin clocks the internal shift register. The serial input (SI) transfers data into the shift register on the falling edge of SCLK while the serial output (SO) shifts diagnostic information out on the rising edge of the serial clock. It is essential that the SCLK pin is in low state whenever chip select \overline{CS} makes any transition.

SI - Serial Input:

Serial input data bits are shifted in at this pin, the most significant bit first. SI information is read on the falling edge of SCLK. Please refer to **Section 8.3** for further information.

SO - Serial Output:

Data is shifted out serially at this pin, the most significant bit first. SO is in high impedance state until the \overline{CS} pin goes to low state. New data will appear at the SO pin following the rising edge of SCLK. Please refer to **Section 8.3** for further information.

8.2 Daisy Chain Capability

The SPI of SPIDER - <u>TLE7244SL</u> provides daisy chain capability. In this configuration several devices are activated by the same \overline{CS} signal \overline{MCS} . The SI line of one device is connected with the SO line of another device (see Figure 10), which builds a chain. The ends of the chain are connected with the output and input of the master device, MO and MI respectively. The master device provides the master clock MCLK, which is connected to the SCLK line of each device in the chain.

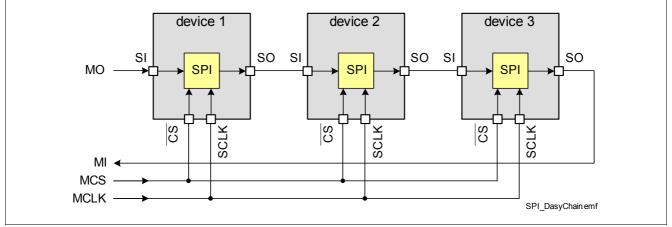


Figure 10 Daisy Chain Configuration

In the SPI block of each device, there is one shift register where one bit from SI line is shifted in each SCLK. The bit shifted out can be seen at SO. After 16 SCLK cycles, the data transfer for one SPIDER - TLE7244SL has been finished. In single chip configuration, the \overline{CS} line must go high to make the device accept the transferred data. In daisy chain configuration the data shifted out at device #1 has been shifted in to device #2. When using multiple devices in daisy chain, the number of bits must be correspond with the number of register bits. Figure 11 is showing a example with 3 SPI devices, where #1 and #3 are 16 bit SPI and #2 has a 8 bit SPI. To get a successful transmission, there have to be 2* 16 bit + 1* 8bit shifted through the devices. After that, the \overline{MCS} line must go high.



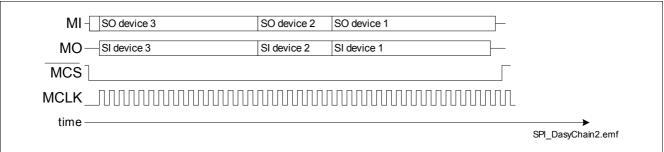


Figure 11 Data Transfer in Daisy Chain Configuration

8.3 SPI Protocol

The SPI protocol of the SPIDER - TLE7244SL provides two registers. The input register and the diagnosis register. The diagnosis register contains eight pairs of diagnosis flags, the input register contains the input multiplexer configuration. After power-on reset, all register bits are set to 1 and the device is in idle mode.

SI						C	Default	: FFFF _F	1						
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
I	N8	IN	17	IN	16	IN	15	IN	14	IN	13	II	12	II	11

Field	Bits	Туре	Description
INn	15:14,	W	Input Register Channel n
(n = 8 - 1)	13:12,		00 _B Stand-by Mode:
	11:10,		Channel is switched off.
	9:8,		Diagnosis flags are cleared.
	7:6,		Diagnosis current is disabled.
	5:4,		01 _B Input Mode:
	3:2,		Channel is switched according to signal at input pin.
	1:0		Diagnosis current is enabled in OFF-state.
			10 _R ON Mode:
			Channel is switched on.
			11 OFF Mode:
			Channel is switched off.
			Diagnosis current is enabled.

Note: If all channels are programmed to Standby, the device changes to power down status with minimum current consumption (sleep mode).



SO															Reset	Value:	1000	0 _H
CS	1)	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	_
TE	۲ C	DL8	D8	OL7	D7	OL6	D6	OL5	D5	OL4	D4	OL3	D3	OL2	D2	OL1	D1	

1) This bit is valid between \overline{CS} hi -> lo and first SCLK lo -> hi transition.

Field	Bits	Туре	Description
TER	CS	R	 Transmission Error Previous transmission was successful (modulo 8 clocks received, minimum 16 bit). Previous transmission failed or first transmission after reset.
OLn (n = 8 - 1)	15,13, 11,9,7, 5, 3, 1	R	Open Load Flag of channel n 0 Normal operation. 1 Open load has occurred in OFF state.
Dn (n = 8 - 1)	14,12, 10,8,6, 4, 2, 0	R	 Diagnosis Flag of channel n Normal operation. Over load or over temperature switch off has occurred in ON state.

8.3.1 Timing Diagrams

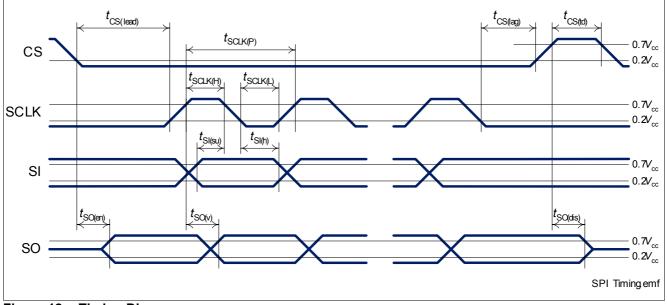


Figure 12 Timing Diagram



8.4 SPI Characteristics

Note: Characteristics show the deviation of parameter at given supply voltage and junction temperature. Typical values show the typical parameters expected from manufacturing.

Electrical Characteristics: Serial Peripheral Interface (SPI)

All voltages with respect to ground, positive current flowing into pin unless otherwise specified: V_{DD} = 3.0 V to V_{DDA}, V_{DDA} = 4.5V to 5.5V, T_{j} = -40 °C to +150 °C

Pos.	Parameter	Symbol	L	imit Val	ues	Unit	Conditions	
			Min.	Тур.	Max.			
Input C	haracteristics (CS, SCLK, SI)	1	_	P			-	
8.4.1	L level of pin		0		0.2*			
	CS	$V_{CS(L)}$			V_{DD}			
	SCLK	V _{SCLK(L)}						
	SI	$V_{SI(L)}$						
8.4.2	<u>H level of pin</u>		0.4*		V_{DD}			
	CS	$V_{CS(H)}$	V_{DD}					
	SCLK	V _{SCLK(H)}						
	SI	V _{SI(H)}				_		
8.4.3	L-input pull-up current through CS	I _{CS(L)}	3	17	40	μA	$V_{\rm CS}$ = 0 V	
8.4.4	H-input pull-up current through \overline{CS}	$I_{CS(H)}$	3	15	40	μA	1)	
							$V_{\rm CS} = 0.4^* V_{\rm DD}$	
8.4.5	L-input pull-down current through		3	12	80	μA	1)	
	pin	7					$V_{\rm SCLK}$ = 0.6 V	
	SCLK	I _{SCLK(L)}					$V_{\rm SI}$ = 0.6 V	
	SI	I _{SI(L)}						
8.4.6	H-input pull-down current through		10	40	80	μA		
	pin	T					V - V	
	SCLK SI	I _{SCLK(H)}					$V_{\text{SCLK}} = V_{\text{DD}}$	
<u></u>		I _{SI(H)}					$V_{\rm SI} = V_{\rm DD}$	
	Characteristics (SO)	T/	0		0.0	\ <u>\</u>	I - 0 - m A	
8.4.7	L level output voltage	V _{SO(L)}	0		0.6	V	$I_{\rm SO}$ = -2 mA	
8.4.8	H level output voltage	V _{SO(H)}	V _{DD} - 0.4 V		V _{DD}		I _{SO} = 1.5 mA	
8.4.9	Output tristate leakage current	$I_{\rm SO(OFF)}$	-10		10	μA	$V_{\rm CS} = V_{\rm DD}$	
Timings	5	1	•					
8.4.10	Serial clock frequency	$f_{\rm SCLK}$	0		5	MHz	1)	
8.4.11	Serial clock period	t _{SCLK(P)}	200			ns	1)	
8.4.12	Serial clock high time	t _{SCLK(H)}	50			ns	1)	
8.4.13	Serial clock low time	t _{SCLK(L)}	50			ns	1)	
8.4.14	Enable lead time (falling \overline{CS} to rising SCLK)	t _{CS(lead)}	250			ns	1)	
8.4.15	Enable lag time (falling SCLK to rising \overline{CS})	t _{CS(lag)}	250			ns	1)	
8.4.16	Transfer delay time (rising \overline{CS} to falling \overline{CS})	t _{CS(td)}	250			ns	1)2)	
8.4.17	Data setup time (required time SI to falling SCLK)	t _{SI(su)}	20			ns	1)	



Electrical Characteristics: Serial Peripheral Interface (SPI)

All voltages with respect to ground, positive current flowing into pin

unless otherwise specified: V_{DD} = 3.0 V to V_{DDA}, V_{DDA} = 4.5V to 5.5V, T_{i} = -40 °C to +150 °C

Pos.	Parameter	Symbol		Limit Val	ues	Unit	Conditions	
			Min.	Тур.	Max.			
8.4.18	Output enable time (falling \overline{CS} to SO valid)	t _{SO(en)}			200	ns	$C_{\rm L}$ = 50 pF ¹⁾	
8.4.19	Output disable time (rising \overline{CS} to SO tri-state)	t _{SO(dis)}			200	ns	C _L = 50 pF ¹⁾	
8.4.20	Output data valid time with capacitive load	t _{SO(v)}			100	ns	$C_{\rm L}$ = 50 pF ¹⁾	

1) Not subject to production test, specified by design.

2) Diagnosis flag update needs the time specified in Chapter 7.1 to get valid information



Application Information

9 Application Information

Note: The following information is given as a hint for the implementation of the device only and shall not be regarded as a description or warranty of a certain functionality, condition or quality of the device.

Figure 13 shows a simplified application circuit. VDD and VDDA need to be externally reverse polarity protected.

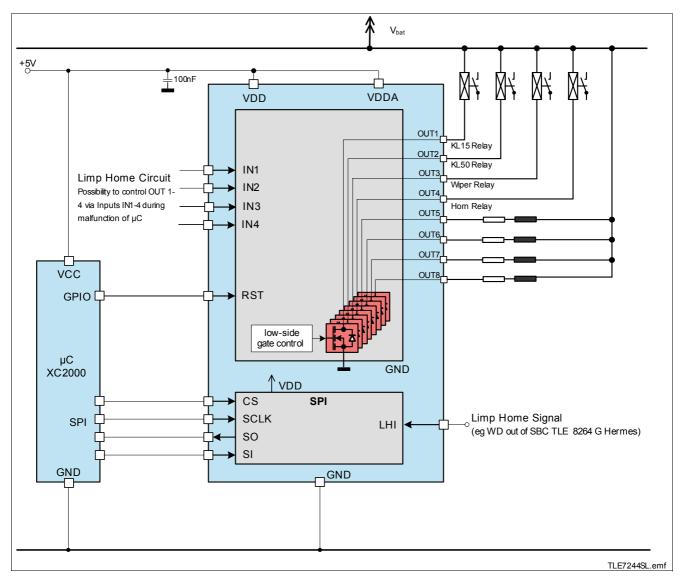


Figure 13 Application Diagram

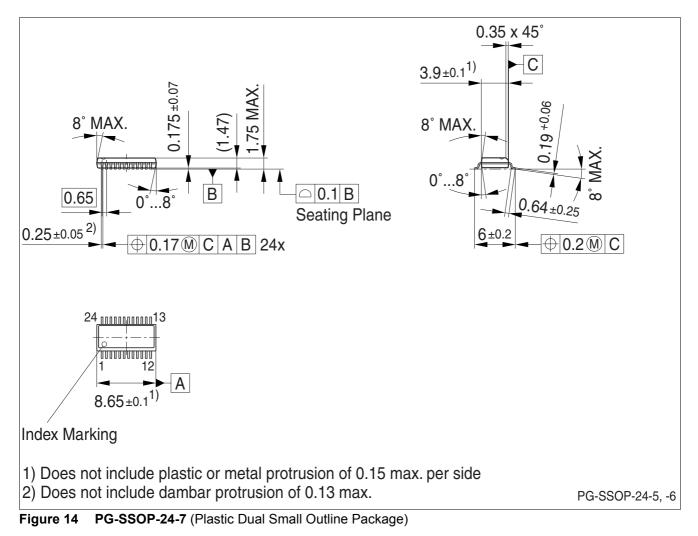
Note: This is a very simplified example of an application circuit. The function must be verified in the real application.

For further information you may contact http://www.infineon.com/spider



Package Outlines

10 Package Outlines



Green Product (RoHS compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

Please specify the package needed (e.g. green package) when placing an order



Revision History

11 Revision History

Version	Date	Changes
Rev. 1.0	2009-09-30	released Datasheet

Edition 2009-09-30

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